

Pan-European



Electronics Design Conference

# Enhanced Modeling and Characterization of Copper Foil for PCB Design

**Lukasz Nowicki, Malgorzata Celuch,  
Marzena Olszewska-Placha, Janusz Rudnicki**

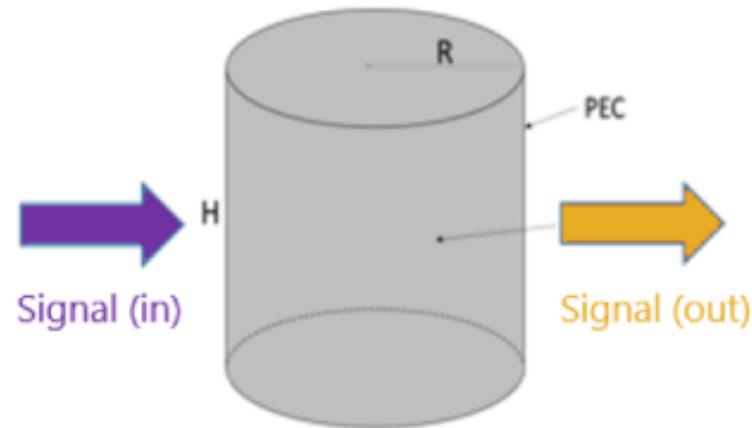
# Outline

1. The **iNEMI** “Copper Foils” Project\*.
2. Introduction - Electromagnetic Insight.
3. Problems of Copper Foil Loss at Higher Frequencies.
4. Experimental Methodology – Sapphire/Ruby Dielectric Resonator & plano-concave Fabry-Perot Open Resonator.
5. Sample preparation & measurement systems.
6. Results – Effective conductivities of copper foils & Correlation with Surface Roughness.
7. Summary and Acknowledgements.

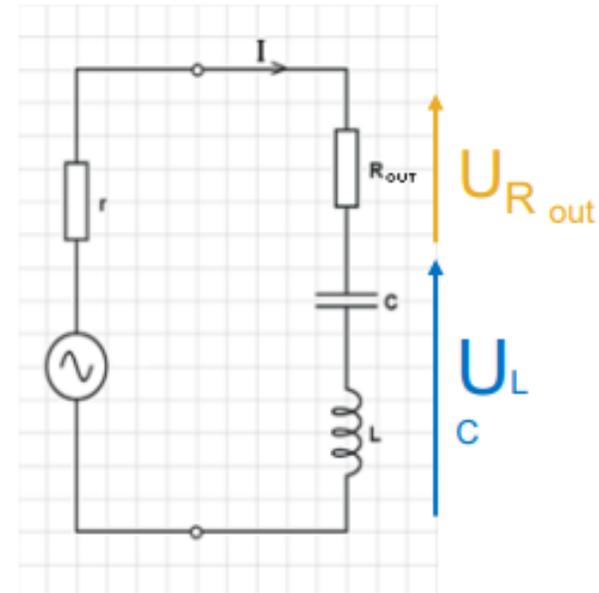
\* **iNEMI** “Copper Foils” Project: “*Reliability & Loss Properties of Copper Foils for 5G Applications*”  
[https://www.inemi.org/article\\_content.asp?adminkey=b5202baac78313e4914809b2f481b372&article=209](https://www.inemi.org/article_content.asp?adminkey=b5202baac78313e4914809b2f481b372&article=209)

# Electromagnetic Insight

## - Why Resonators for Material Measurements?



given fixed strength of **Signal(in)**,  
at resonance **Signal (out)** is strongest



given fixed strength of  $U_{in}$ ,  
at resonance  $U_R$  is strongest ( $U_{LC} = \text{zero}$ )

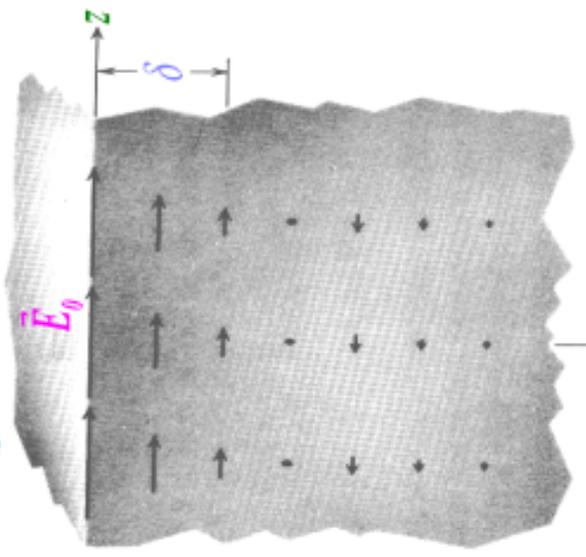
- The resonance is sharpest (narrow-band, high-Q) when the resonator is composed of ultra-low-loss materials.
- Hence, the resonant methods are specifically suitable for characterising 5G/mmWave materials.

# Why Copper Loss Becomes More problematic at Higher Frequencies

current at the surface  
related to E-field at the surface:

$$J_0 = E_0 \sigma$$

→ wave incidence



→ problems common for metallic surfaces (bulk or foil)

penetration depth  
(fields & currents  
attenuated e-times)

$$d_p = \sqrt{\frac{2}{\omega \mu_0 \sigma}}$$

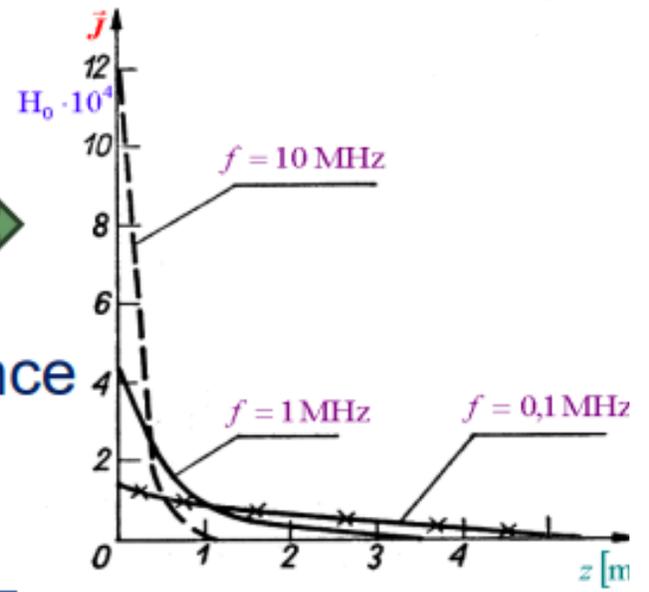
current integrated over depth  
(so called surface current):

$\sigma$ [S/m]	$d_p$ [ $\mu\text{m}$ ] @13.5 GHz non-magnetic metal
1.00E+03	135.8309
1.00E+04	42.9026
1.00E+05	13.5588
1.00E+06	4.2871
1.00E+07	1.3556
5.00E+07	0.6063

surface  
resistance  
(sheet  
resistance)

$$R_s = \frac{1}{\sigma d_p} = \sqrt{\frac{\pi f \mu_0}{\sigma}}$$

→ wave incidence



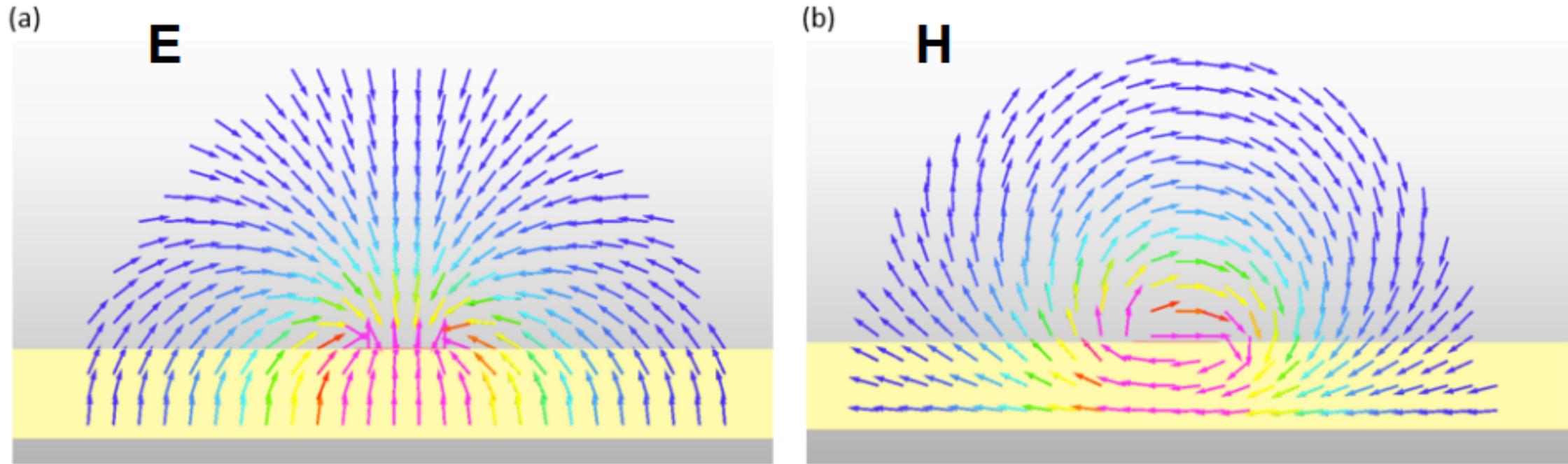
Total current ("surface current")  
flowing along the metallic surface  
is equal to the incident H-field amplitude  
(does not depend on frequency or metal  
conductivity).

At higher frequencies, this current flows in a  
thinner layer below metal surface, hence,  
experiences a higher resistance.

# Why Both Sides of a Copper Foil Should Be Measured

We model a 50 Ohm microstrip line.

FDTD simulator is used to simulate field patterns and calculate transmission losses.

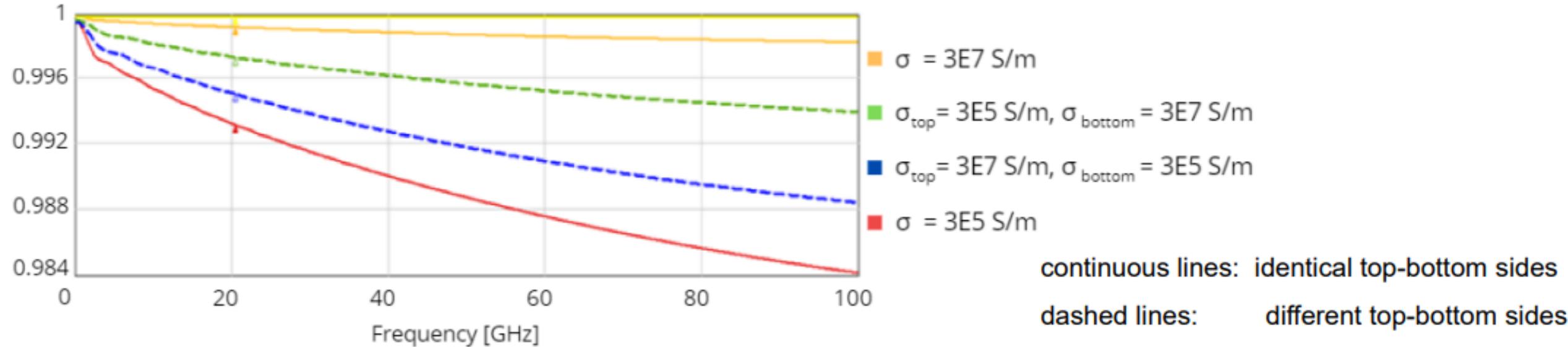


A 50 Ohm microstrip line and the (a) electric field and (b) magnetic field propagating through it.

Higher field intensity below the strip → higher contribution of the bottom side of the strip to signal losses.

# Why Both Sides of a Copper Foil Should Be Measured

Predictions based on field patterns are confirmed by simulating a segment of the line, with a dual-side microstrip (conductivities to the bottom and upper side assigned independently in the model).



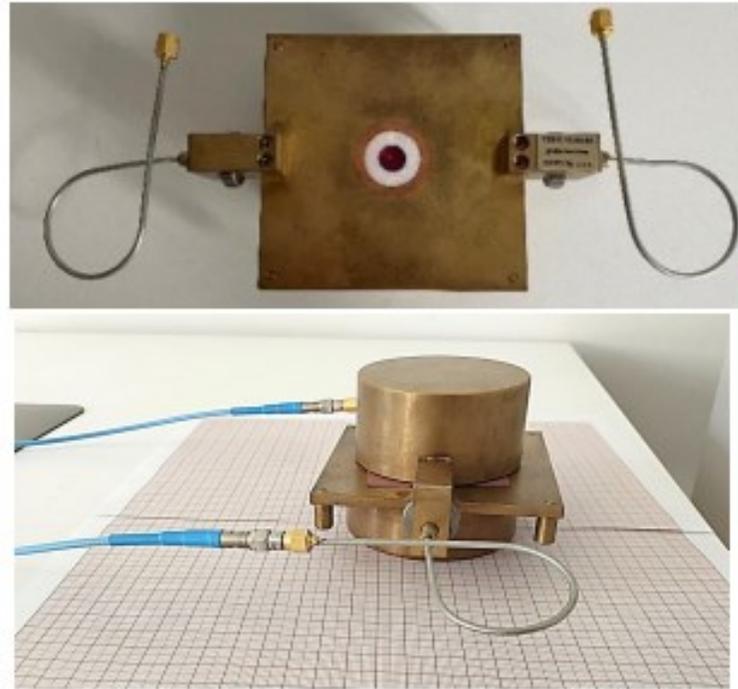
**Segment of the line, with a dual-side microstrip - conductivities to the bottom and upper side assigned independently in the model**

Note:

differences in bottom-top conductivities are exaggerated, to capture differences in transmission loss along a short segment of the line.

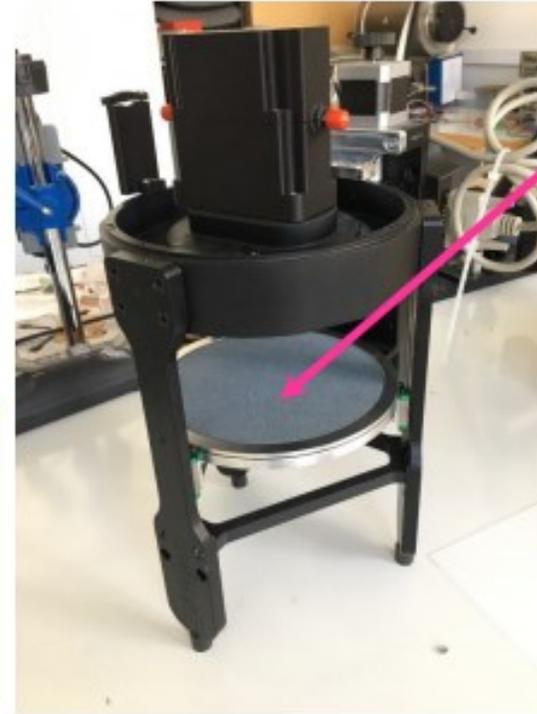
# Experimental Methodology – Sapphire/Ruby Dielectric Resonator & Fabry-Perot Open Resonator

Dielectric Resonator:  
Sapphire (SaDR) or Ruby (RuDR)



$$R_s = \sqrt{\frac{\pi f \mu}{\sigma_{\text{eff}}}}$$

effective parameter,  
lower than bulk copper,  
including the effects  
of inhomogeneity  
(roughness, treatment)



Fabry-Perot Open Resonator  
(modified to planar-concave design)  
sample holder;  
vacuum pump to be applied from below



Both RuDR (SaDR) and FPOR resonators allow measuring a copper foil by itself:

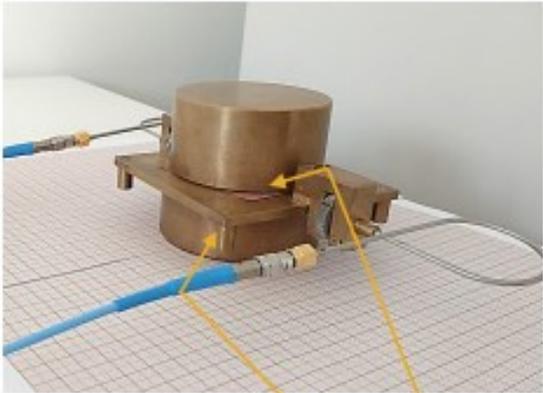
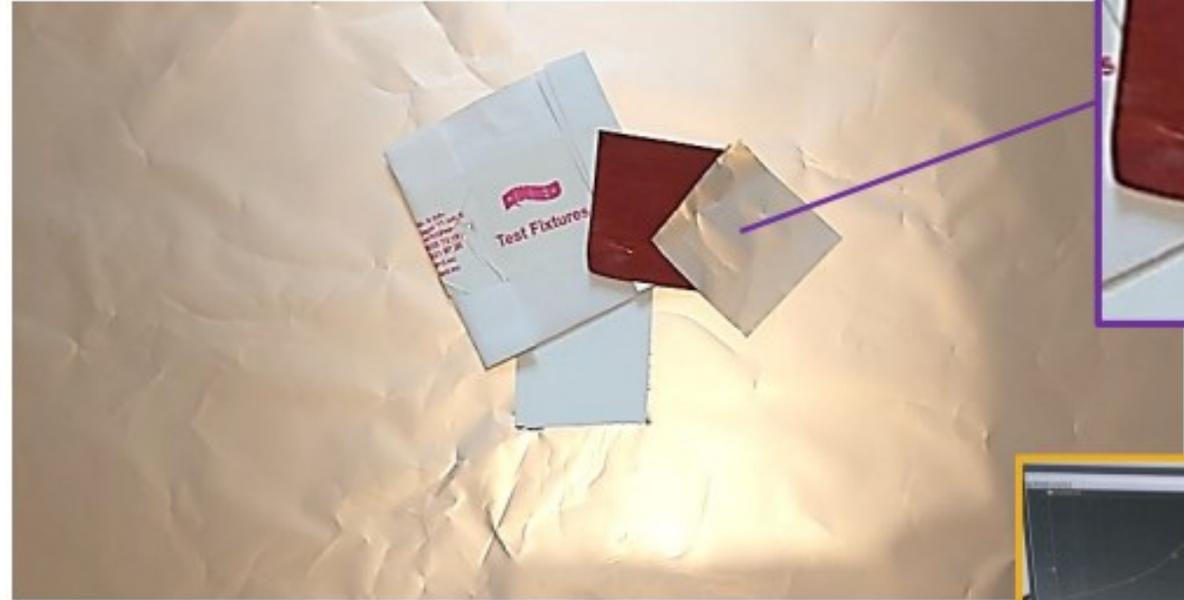
- no need to fabricate a test circuit!
- loss from the foil is separated from any dielectric loss,
- the two sides of foil can be measured separately,
- foils on laminates can also be measured.

# Sample preparation – Copper foils

„Rough” side of the sample

„Shiny” side of the sample

Samples measured on the same side



Sample



Reading the resonant frequency and Q-factor from the VNA and entering it into dedicated software to calculate surface resistance and conductivity.

# Measurement systems



example  
of a measurement kit

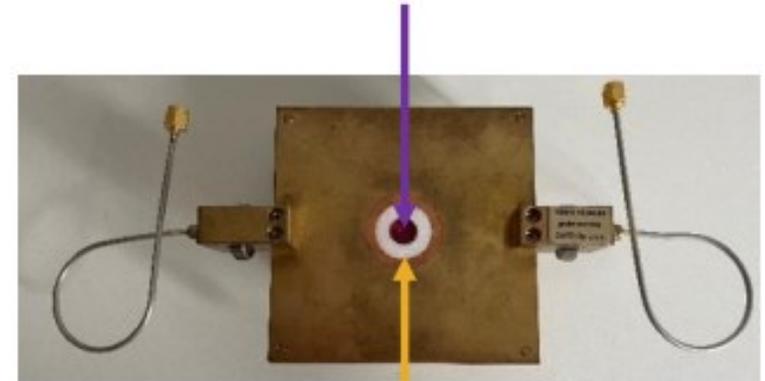
**Losses** of the resonator come from:

**mainly:** bottom & top plates made by the sample-under-test  
(pressed with metal blocks for electrical contact &  
mechanical robustness),

**additionally:** cavity side walls & ruby itself  
(minimised & calibrated out via the modelling).

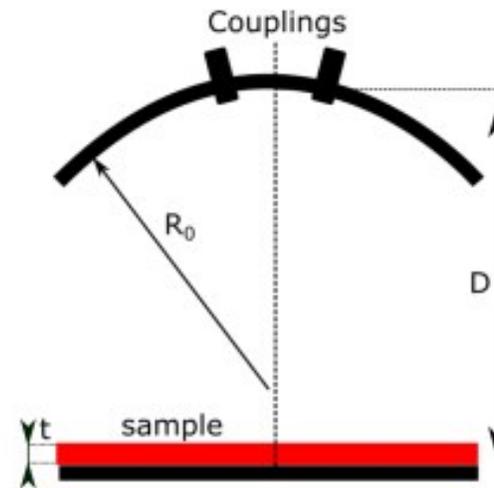
- It operates at nominal frequencies of **13 GHz** and **21 GHz**.
- Two identical metallic samples are required for measurements.
- The samples should have dimensions of at least **23 mm x 23 mm**.
- The dedicated software calculates material parameters based on the measured data: resonance frequency and Q-factor (extracted through VNA).

A cylinder of high-permittivity dielectric  
(sapphire or **ruby**) forms the resonator.



It is mounted in a cylindrical cavity via a teflon ring.

# Measurement systems

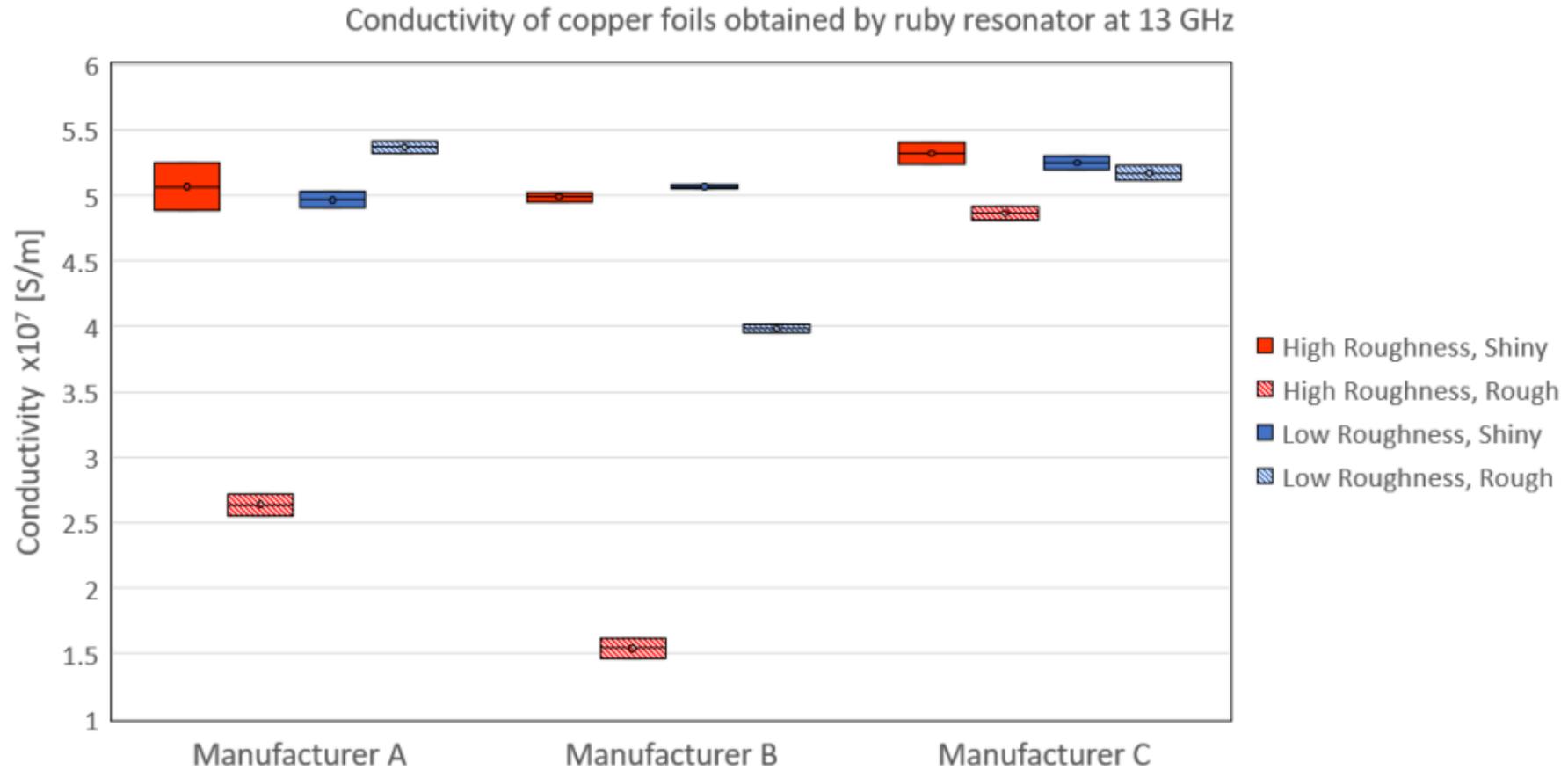


sample size  
90mm x 90mm



- FPOR allows** broadband and precise resonant measurements of electromagnetic properties of materials. It is adapted to copper foil measurements by:
- replacing the classical double-concave mirrors with planar-concave design (the foil-under-test forms the planar mirror),
  - a vacuum pump is applied for fixing the foil,
  - dedicated software is developed (for converting measured resonant frequencies & Q-factors to foils' effective conductivity).

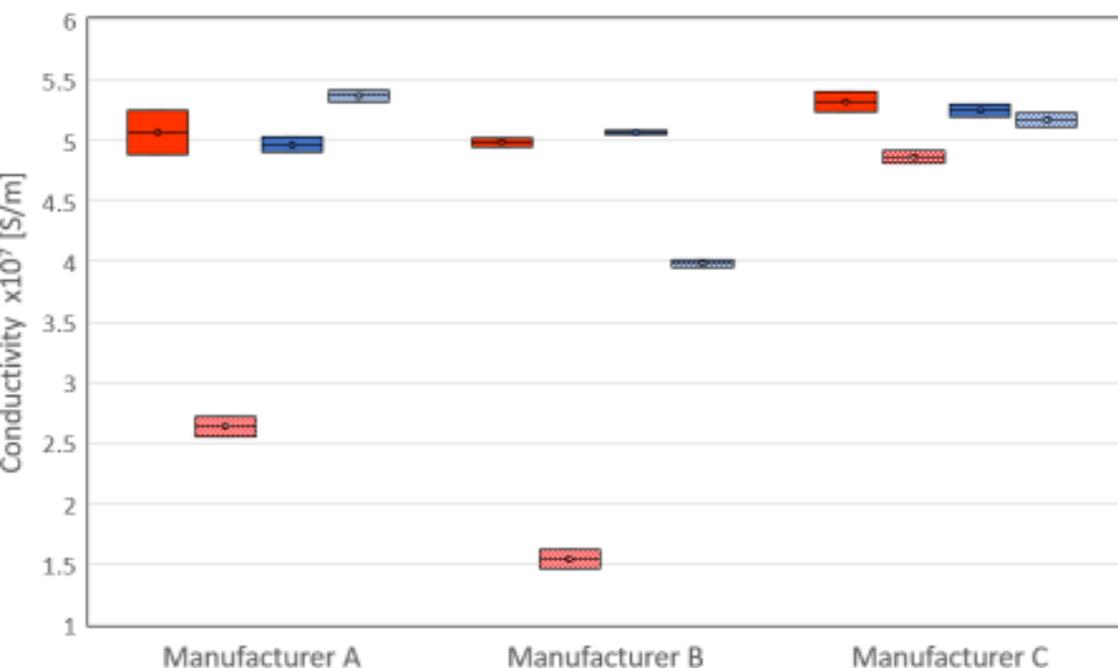
# Results – Effective conductivities of copper foils



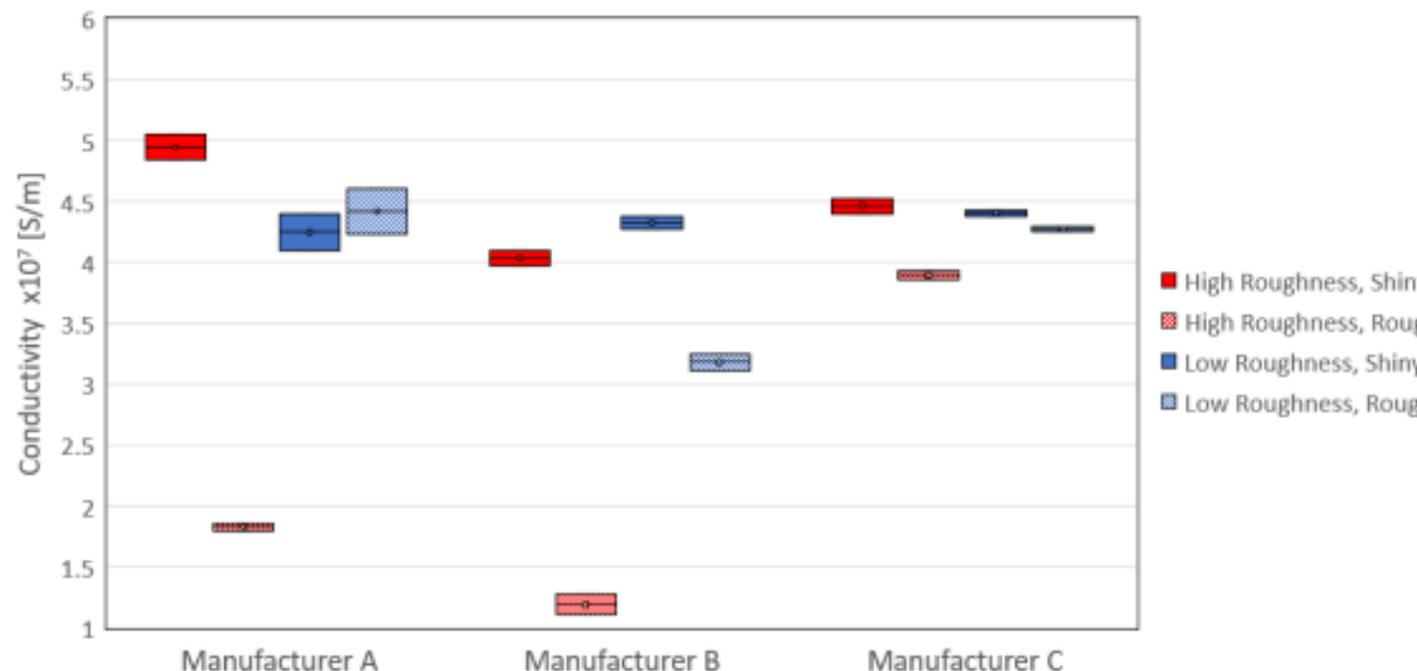
- Copper foils exhibit lower effective conductivity than bulk copper.
- Copper foils from 3 different manufacturers, of both High- and Low-roughness, exhibit similar (within 10%) effective conductivities when measured on the “shiny” side (ca.  $5 \div 5.5 \times 10^7$  S/m).
- “Rough” side of high-roughness foils has lower conductivity (even by a factor of 2-3, depending on the manufacturer).
- For Low-roughness foils, the difference between the “shiny” and “rough” sides is less significant (with even an anomaly for one manufacturer).

# Results – Effective conductivities of copper foils

Conductivity of copper foils obtained by ruby resonator at 13 GHz



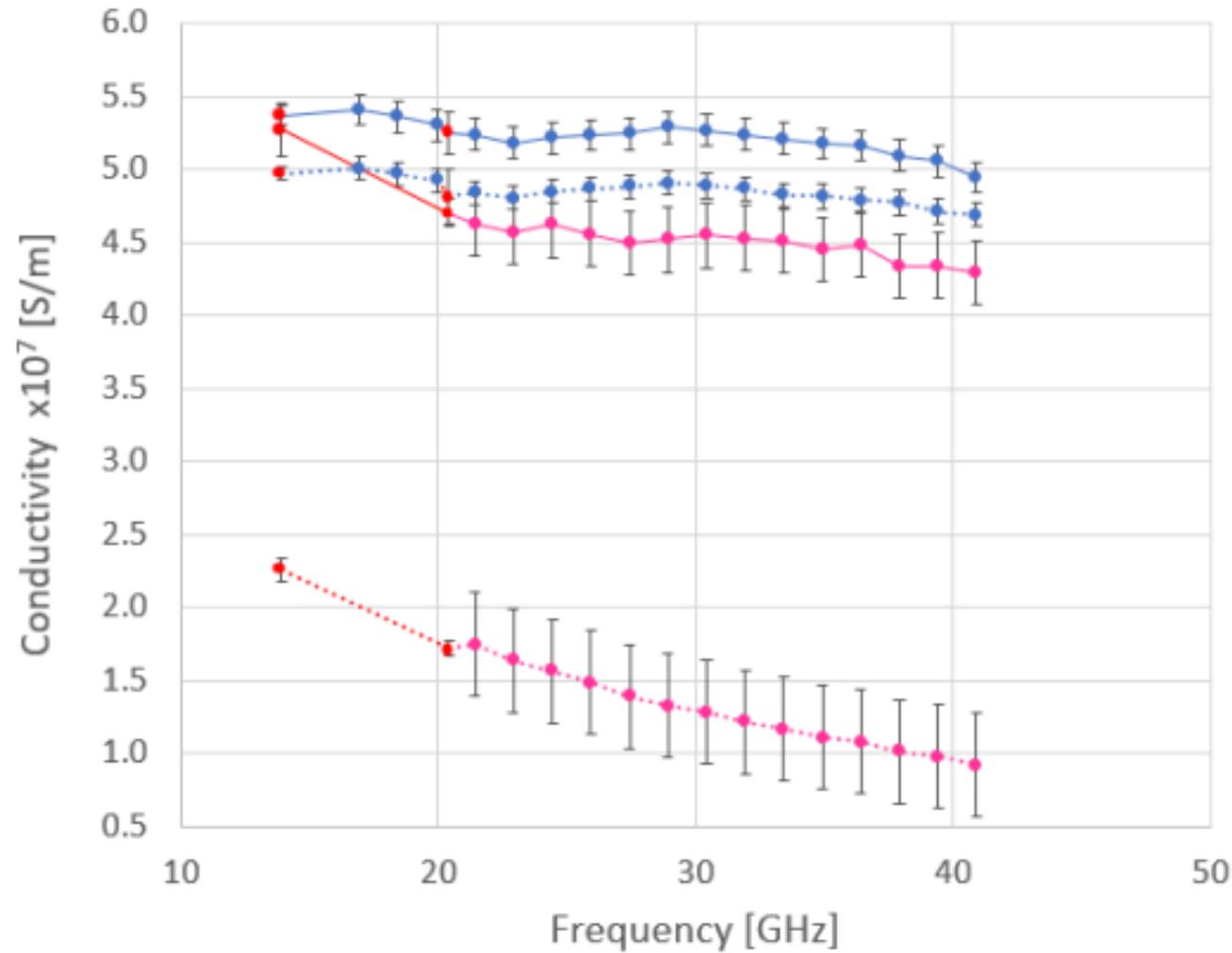
Conductivity of copper foils obtained by ruby resonator at 21 GHz



At the higher frequency of 21 GHz:

- All measured effective conductivity values tend to be lower than at 13 GHz.
- Differences between the manufacturers become more significant.
- Copper foils from only one manufacturer, of one type (High-roughness, shiny side) maintain effective conductivity at the level of  $5 \times 10^7$  S/m. Other ones drop below  $4.5 \times 10^7$  S/m.

# Results – Effective conductivities of copper foils



**Manufacturer A**  
– Low&High Roughness case

• Ruby Resonator RuDR

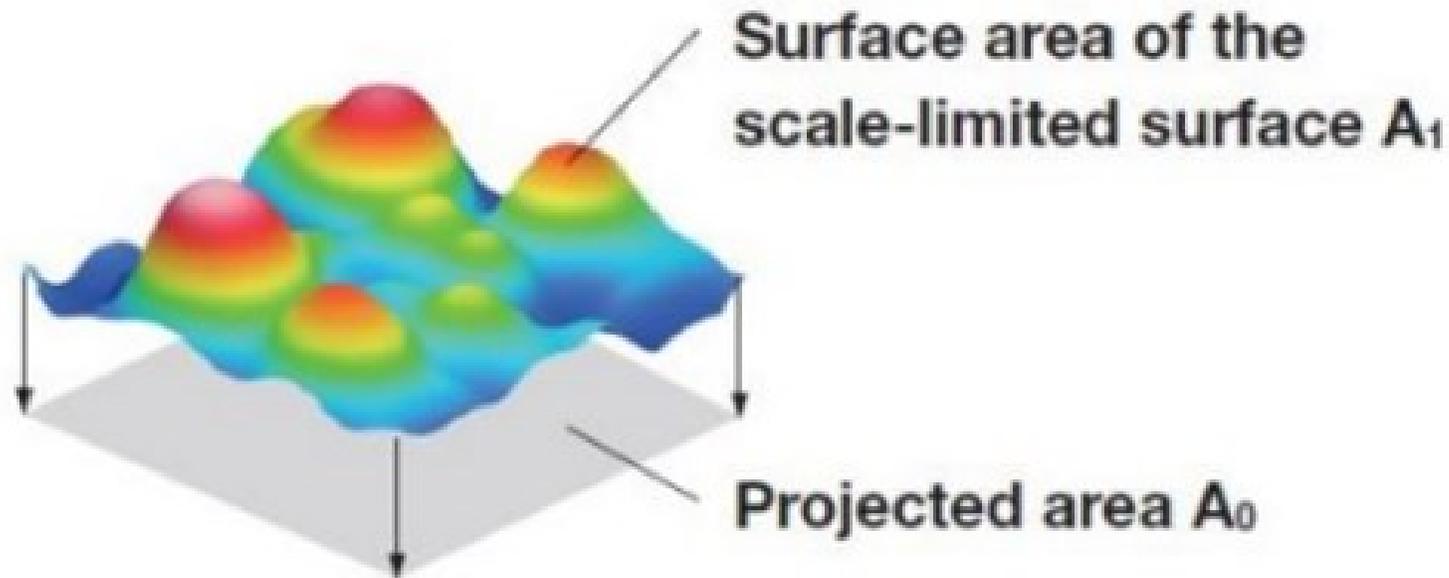
— High Roughness, Shiny  
- - High Roughness, Rough  
— Low Roughness, Shiny  
- - Low Roughness, Rough

} FPOR

- effective conductivity decreases with frequency → signal loss will increase
- differences between the two sides of copper must be taken into account

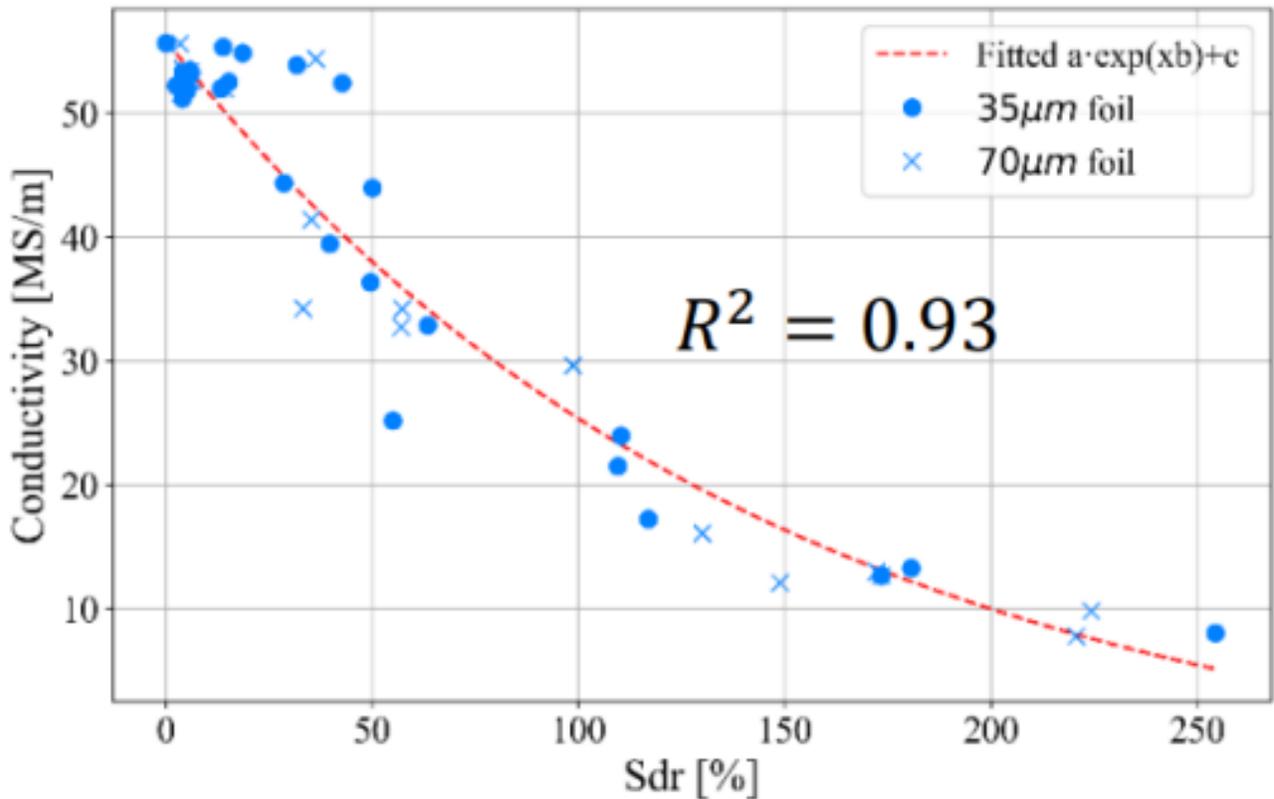
# Roughness parameters (contact stylus profilometre)

Developed interfacial area ratio ( $S_{dr}$ )

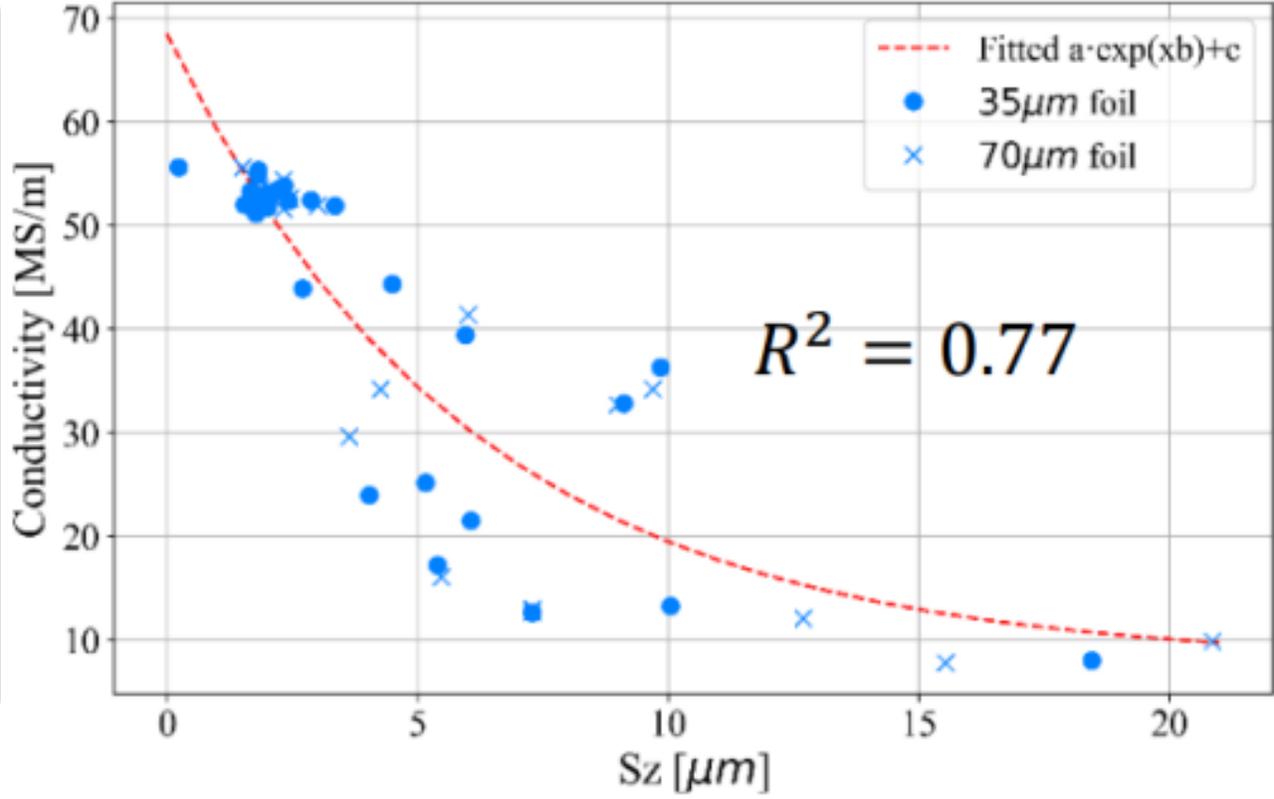


\* [https://www.olympus-ims.com/en/metrology/surface-roughness-measurement-portal/parameters/#lcms\[focus\]=cmsContent14708](https://www.olympus-ims.com/en/metrology/surface-roughness-measurement-portal/parameters/#lcms[focus]=cmsContent14708)

# Correlation Between Effective Conductivity and Surface Roughness



( $a=61.4$  MS/m,  $b=-6.87 \cdot 10^{-3}$ ,  $c=-5.59$  MS/m)



( $a=60.7$  MS/m,  $b=-0.16$  1/µm,  $c=-7.82$  MS/m)

Better fit with noncontact parameters  
But still not perfect fit.



# Summary

- Measurements are conducted on copper foils in their delivered state from three manufacturers, covering high- and low-roughness variants. The study includes both "rough" and "shiny" sides of each foil type, with six sheets per type, enabling a comprehensive analysis of sample and measurement reproducibility. Averages and standard deviations are calculated.
- Measurements show that, for higher frequencies (mmWave):
  - effective conductivity of all copper foils decreases (hence, electric loss increases) with frequency,
  - differences in loss due to different manufacturers and copper types increase,
  - differences of signal loss due to different conductivity of the two sides of copper need to be taken into account in circuit design.

We have confirmed that increasing roughness leads to higher loss.

- However we have also shown that roughness-to-loss is not represented by a closed-form formula.
- Sz or Sdr (from non-contact roughness measurement) give higher correlation to loss, than Rz (from contact measurement).

It is recommended to measure foils before their application in mm-Wave circuit design.

As further expected in view of the electromagnetic considerations, foil thickness is irrelevant.

# Acknowledgment

QWED team wishes to thank all the partners, of all the iNEMI “5G” projects,  
for their great collaboration in the benchmarking activities.

With this presentation, we specifically acknowledge the collaboration in the iNEMI “Copper Foils” Project:  
“Reliability & Loss Properties of Copper Foils for 5G Applications”

- This work was supported by the Polish National Centre for Research and Development, within the M-ERA.NET I4Bags project (under contract M-ERA.NET3/2021/83/I4BAGS/2022), ULTCC6G\_Epac (M-ERA.NET2/2020/1/2021) EUREKA-Eurostars 5G\_Foil project (DWM/InnovativeSMEs/176/2023).



ULTCC6G\_EPac

